

July 13, 2009

CN-071309

Customer Notification

Test Site Transfer

Dear Valued Customer:

This notification is for the purpose of informing you of a test site transfer and additional shipping locations for the products listed below.

Purpose

STATS ChipPAC has announced the closure of their facility in San Diego, California. Mindspeed will transfer the test of affected products to test locations that are already qualified by Mindspeed and in high volume operation. These test locations are ASE in Malaysia and Amkor in the Philippines. There are no changes to the test equipment, test hardware, and test programs used for these products. Where possible, Mindspeed will utilize both ASE in Malaysia and Amkor in the Philippines.

Products currently tested by STATS ChipPAC in San Diego, California, are packaged and shipped by Jazz Semiconductor in Newport Beach, California. Because ASE in Malaysia and Amkor in the Philippines are both qualified shipping locations, the products listed below will also have ASE Malaysia and Amkor Philippines as shipping locations. Jazz will remain as a second site for shipping these products. There will be no changes made to the shipping containers for these products.

The tables below identify the products transferring to ASE Malaysia or both ASE Malaysia and Amkor Philippines.

Products transferring to ASE in Malaysia:

M02061-12	28236-12	M28335-14	CX28344-11	CX28366G-14
M02061G-21	28236-22	M28335-15	CX28344G-11	28478-17
M02061G-12	28236G-12	M28335G-15	CX28364-14	28478-18
M02094-12	28237-12	CX28342-11	CX28364G-14	28478G-17
M02094G-12	28237G-12	CX28342G-11	CX28365-14	28478G-18
M21328G-12	28237L-12	CX28343-11	CX28365G-14	CX28500-12
M21443G-13	M28335-13	CX28343G-11	CX28366-14	CX28500G-12

Products transferring to both ASE in Malaysia and Amkor in the Philippines:

28235-15	M28352G-15	M28354G-15	M28525-12	M28529G-12
28235G-15	M28353-15	M28356-15	M28525G-12	M28985-21
CX28348	M28353G-15	M28356G-15	M28529-12	M28985G-21
M28352-15	M28354-15			

Change Schedule

Customers may begin to receive product from the new test and shipping sites beginning on August 7, 2009. Mindspeed will continue to ship product from the current location, Jazz Semiconductor, that has already been tested at STATS ChipPAC, and convert to the new test locations based on the demand by our customers' orders.

Method to identify parts

The labels attached to the vacuum bags, inner boxes, and outer boxes identify the location where the product is packaged and shipped.

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Customer Impact

No customer impact is anticipated with this change; there is no change to form, fit, or function. Qualification data will be available upon request.

We are confident this change will allow Mindspeed Technologies to maintain its high standards for quality and reliability. We will be managing this change very closely to ensure minimum disruption to our customers. If, at any time, you have a need for further information, please contact your local Sales Representative.

The indicated Customer Notification letter was received and acknowledged by the undersigned authority.

Name: _____
Signature _____ Print _____

Company: _____
Name _____ Location _____

Title: _____

Date: _____

Comments/additional requests: _____

Thank you for your attention on this matter.

Please return the acknowledgment form to the attention of Dan McCarville at Mindspeed Technologies Inc., 4000 MacArthur Blvd, Newport Beach, Ca, 92660;
daniel.mccarville@mindspeed.com.